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# Effect of applied stress on passivation kinetics and passivation modelling of 304L stainless steel in acidic medium

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## 1 Passivation Role in Stress Corrosion Cracking (SCC):

Film rupture-dissolution model (FRM): describes intergranular SCC, shown in Fig.1, as repetitive cycles of local surface activation, dissolution, and passivation near the crack tip [1]. Fig. 2 illustrates one of these cycles as described next:

Mechanical

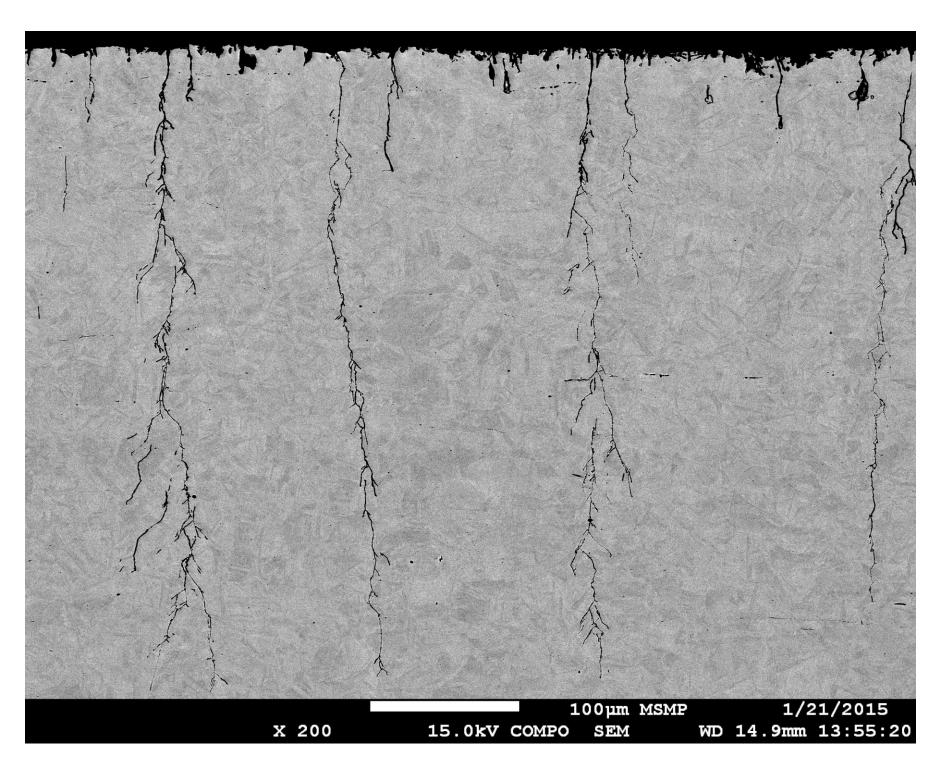
Slip-induced passivity breakdown causing fresh surface exposure to corrosive environment. (process1-2 in Fig.2 and 3)

Electrochemical

Excessive material dissolution takes place until the surface repassivates again. (process 3-4 in fig. 2 and 3)

### **Objectives**

- To develop a model quantifying the passivation kinetics and parameters of passive films constructed in acidic medium.
- To use this model to check the influence of stress on stainless steel passivation and passive film quality.



**Fig.1:** SCC of 304L stainless steel after 88 h immersion in 2 M H2SO4 + 0.5 M NaCl.

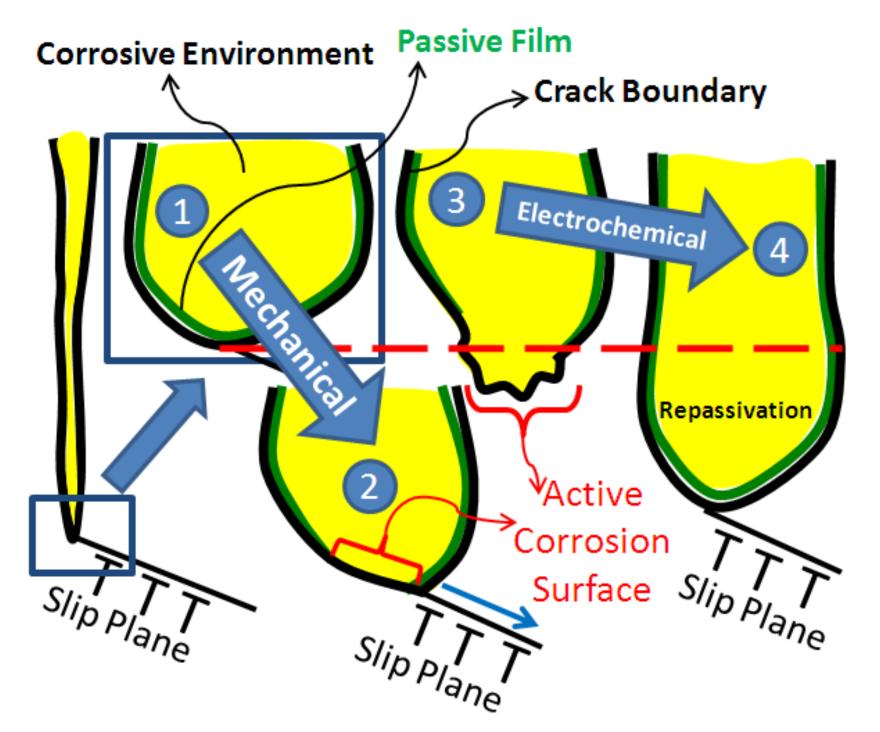
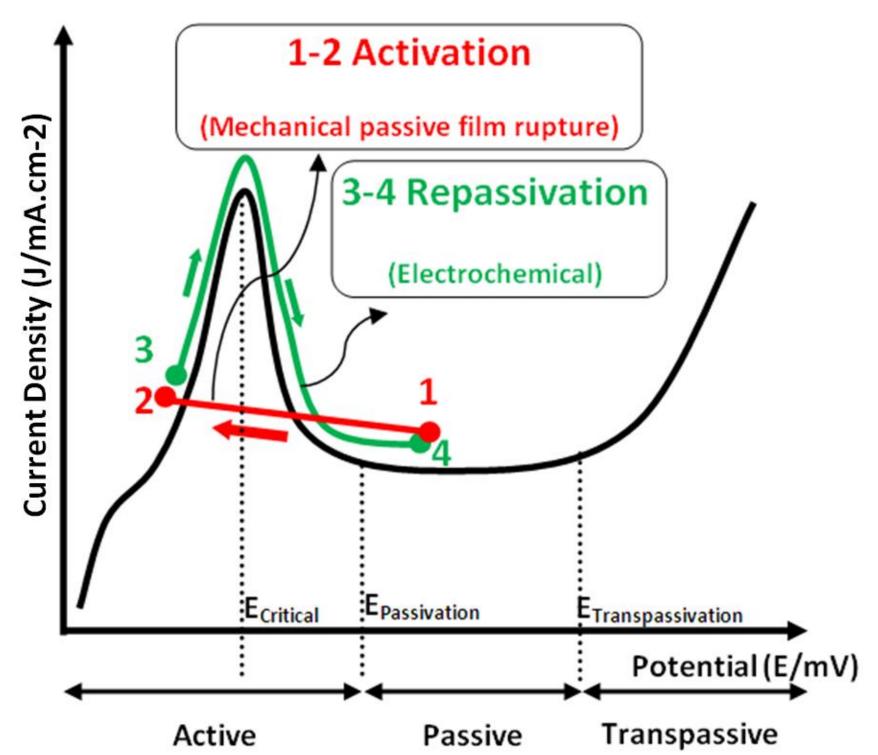


Fig.2: Representation of crack propagation by the film rupture-dissolution model.



**Fig.3:** Polarization curve sactivation/passivation cycle.

showing an

## Quantification of Passive Film Thickness and Quality in Acidic Medium:

#### **Atomic Emission Spectroscopy and Conventional Electrochemical Experiments**

- Stressed and non-stressed samples of 304L stainless steel are subjected to potentiodynamic cycling tests as shown in Fig. 2. →These serve as an electrochemical simulation of SCC activation/passivation cycle as described by FRM.
- Experiments were performed in 2 M H2SO4 solution at room temperature.
- In-situ atomic emission spectroelectrochemistry **(AESEC)** [3] was coupled with conventional electrochemistry during the tests. 

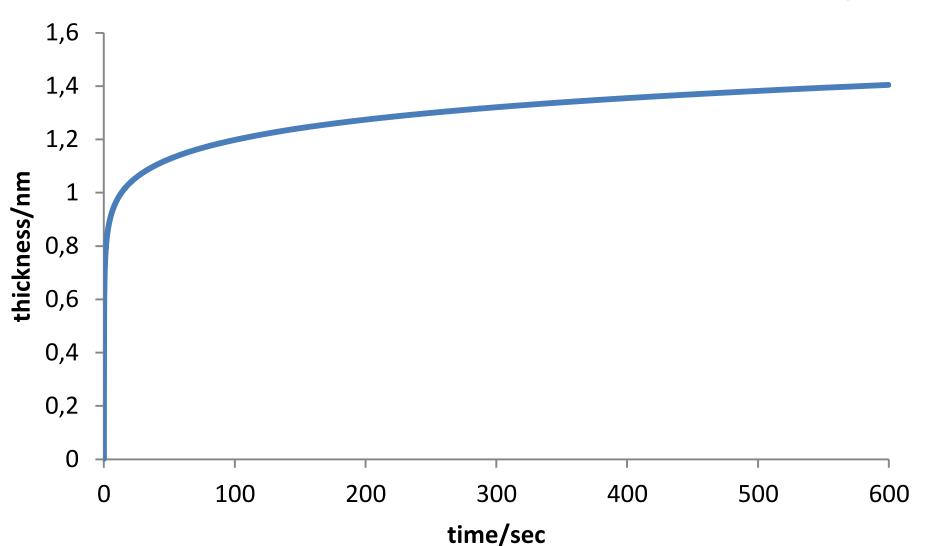
  By this, the passivation current due to metallic dissolution can be quantified, as shown by Fig. 4.

#### **High Field Ion Conduction Model and Passive Film Thickness (HFIC)**

- HFIC was adapted to describe the current evolution during passivation [2], as given by eq.1.
- Passive film thickness can be calculated using Faraday's law as indicated by eq.2.
- The term  $q_{film}$  represents the charge exchange responsible for passive film formation.
- The external current during passivation is due to three components as explained by eq.3.
- In acidic solutions, the major part of anodic current measured during passivation is due to metallic dissolution [2,3], where  $i_{cathodic}$  is negligible [3].
- The portion of charge due to film formation can be calculated by quantifying the dissolution component as given by equation 5 and 6.
- A particular approximation is taken as  $i_{external} = i_{dissolution}$  to calculate the current fraction due to iron dissolution  $f_{Fe}$ . By this,  $f_{Fe}$  can be calculated as given by eq.7.
- The calculation of  $f_{Fe}$  is based only on the metallic mass fractions in the alloy and their oxidation numbers in such acidic medium as derived from Faraday's second law  $\rightarrow$  eq.8.
- Using AESEC quantified data for metallic dissolution during passivation (region C in Fig.4),  $i_m/i_{Fe}$  can be calculated. This ratio can be used in eq.9 to calculate  $f_m$  for the concerned metals.  $\Rightarrow$  By eq.2, passive film thickness is calculated as shown in Fig.5.

#### Influence of Stress on Passive Film Thickness and Quality:

- For stressed samples  $\rightarrow$  slightly higher charge exchange  $\rightarrow$  thicker passive film. (1.64 vs 1.58 nm  $\pm$ 0.03).
- Slopes of curves in Fig. 6 = cBV. → a direct measure of the passivation rate and the film ionic conductivity.
   → cBV is inversely proportional to the film quality [4]. Fig. 7 shows this factor for stressed and unstressed cases.



**Fig.5**: Passive film thickness formed during the passive as calculated by eq.2.

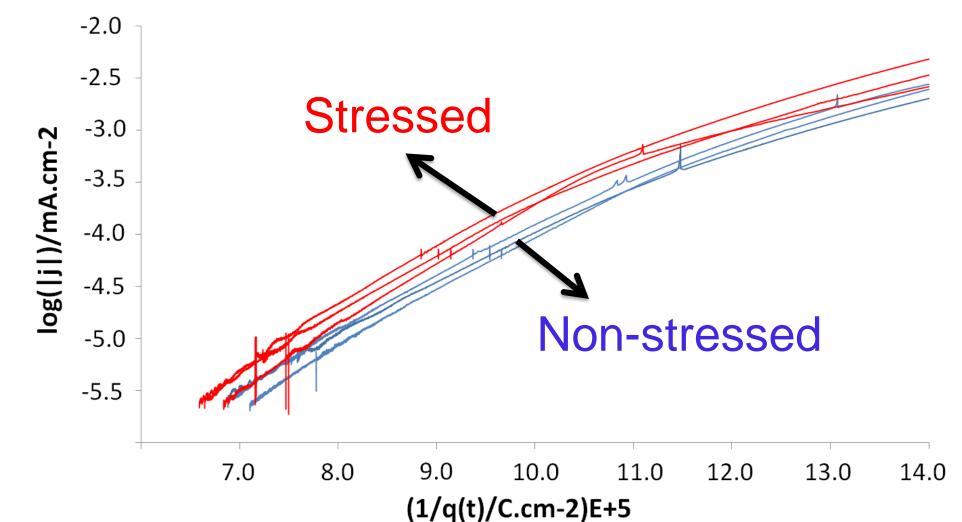
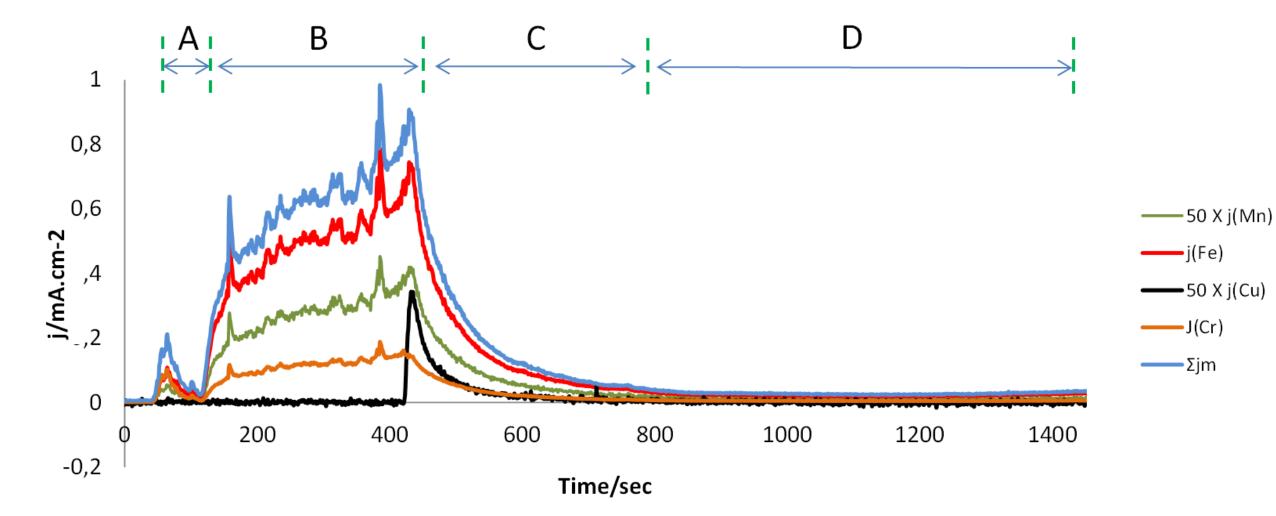


Fig.6: Experimental passivation transients based on eq.10 during the anodic pulse.



**Fig.4:** AESEC experiment showing the metallic dissolution current densities during a potentiodynamic activation/passivation cycle. A: activation pulse. B: Open circuit potential **(OCP)**. C: Passivation pulse. D: OCP.

$$i(t) = A \exp\left(\frac{BV}{h(t)}\right) \tag{1}$$

$$h(t) = \frac{Mq(t)_{film}}{7E0} \tag{2}$$

$$i_{external=i_{dissolution}+i_{film}+i_{cathodic}}$$
 (3)

$$q(t)_{total} = \int_{t=0}^{t} i_{external}(u) du$$
 (4)

$$q(t)_{film} = q(t)_{total} * (1 - f_{dissolution})$$
 (5)

$$f_{dissolution} = (f_{Fe} + f_{Cr} + f_{Mn} + f_{Cu})_{dissolved}$$
 (6)

$$f_{Fe} = \frac{l_{Fe}}{l_{Fe} + l_{Fe} + l_{Fe}} \tag{7}$$

$$i_m = \frac{m.F.z}{t.M} \tag{8}$$

$$f_m = \frac{\iota_m}{\iota_{Fe}} \times f_{Fe}$$

$$\log i(t) = \log A + \frac{BzF\rho V}{2.3 M q(t)_{film}}$$
(9)

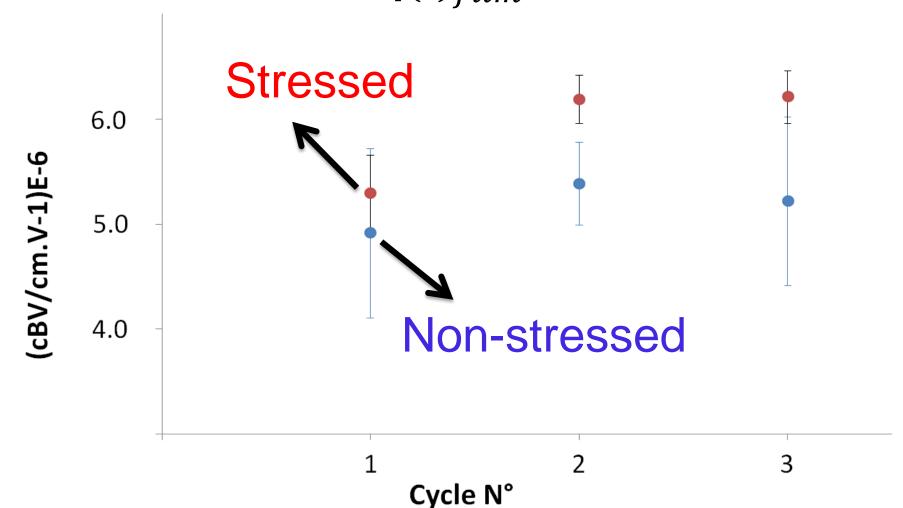


Fig.7: cBV values indicate less protective passive film built over stressed samples than that for non-stressed ones.

References: [1] J.C. Scully, Corrosion Science, 15 (1975): p 207.

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[4] N. Cabrera, N.F. Mott, Rep. Prog. Phys. 12 (1948): p. 163